General Description

The SJM010N850 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a wide variety of applications.

Features

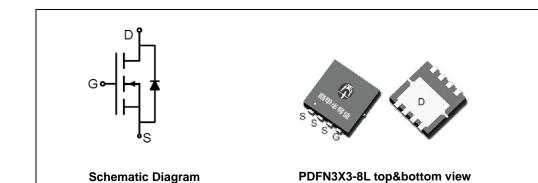
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

Key Performance Parametes

Parameter	Value	Unit
V _{DS}	100	V
R _{DS(ON)_} TYP	82	mΩ
ID	11	А
Q _G	20.2	nC



Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJM010N850	SJM010N850	PDFN3X3-8L	Tape	\	/	5000 Pcs

Table 1. Absolute Maximum Ratings (T_C=25℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V _{DS}	Drain-Source Voltage (V _{GS} =0V)	100	V
Vgs	Gate-Source Voltage (V _{DS} =0V)	±20	V
1-	Drain Current-Continuous(Tc=25°C)	11	А
I _D	Drain Current-Continuous(Tc=100℃)	7	А
I _{DM} (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	44	А
Maximum Power Dissipation(Tc=25℃)		23	W
P _D	Maximum Power Dissipation(T _C =100°C)	9	W
E _{AS}	Avalanche energy (Note 2)	25	mJ
TJ, TSTG	Operating Junction and Storage Temperature Range	-55 To 150	C

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
Rejic	Thermal Resistance, Junction-to-Case		5.5	°C/W



Table 3. Electrical Characteristics (T_J=25℃ unless otherwise noted)

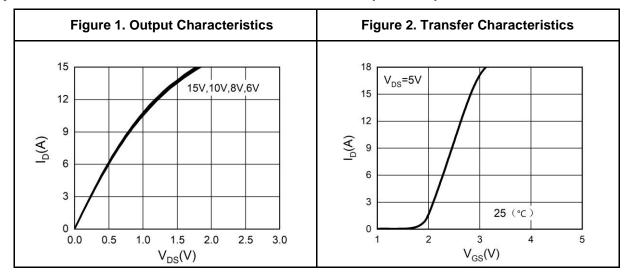
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States	•					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =250μA	100			V
		V _{DS} =100V, V _{GS} =0V T _J =25℃			1	μΑ
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =100V, V _{GS} =0V T _J =125 °C			100	μΑ
lgss	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250µA	1		2.5	V
g FS	Forward Transconductance	V _{DS} =5V, I _D =6A		6		S
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =10V, I _D =6A T _J =25℃		82	102.5	mΩ
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =4.5V, I _D =4A T _J =25℃		85	113	mΩ
Dynamic Chara	octeristics			•		•
Ciss	Input Capacitance			951		pF
Coss	Output Capacitance	V _{DS} =50V,V _{GS} =0V, f=1.0MHz		32.3		pF
Crss	Reverse Transfer Capacitance			27.3		pF
Rg	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1.0MHz		1.3		Ω
0Switching Par	ameters					
t _{d(on)}	Turn-on Delay Time			6.6		nS
t _r	Turn-on Rise Time	$V_{GS}=10V$, $V_{DS}=50V$, $R_{L}=8.3\Omega$, $R_{GEN}=3\Omega$		46		nS
$t_{d(off)}$	Turn-Off Delay Time			31		nS
t _f	Turn-Off Fall Time			4		nS
Qg	Total Gate Charge			20.2		nC
Qgs	Gate-Source Charge	V _{GS} =10V, V _{DS} =50V, I _D =6A		2.1		nC
Q_gd	Gate-Drain Charge			4.2		nC
Source-Drain D	liode Characteristics					
I _{SD}	Source-Drain Current (Body Diode)				11	Α
V _{SD}	Forward on Voltage (Note 3)	V _{GS} =0V, I _S =6A			1.2	V
t _{rr}	Reverse Recovery Time	I _F =6A, dI/dt=100A/μs		26		ns
Qrr	Reverse Recovery Charge	I _F =6A, dI/dt=100A/μs		35		nC

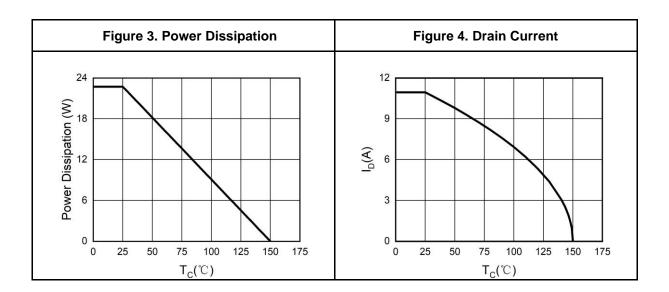
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

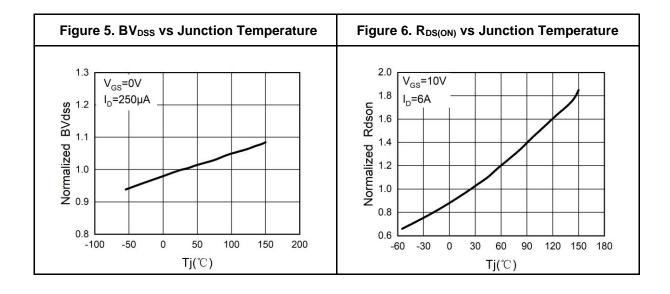
Notes 2.E_{AS} condition: $T_J=25^{\circ}C$, $V_{DD}=40V$, $V_{G}=10V$, $Rg=25\Omega$, L=0.5mH.

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

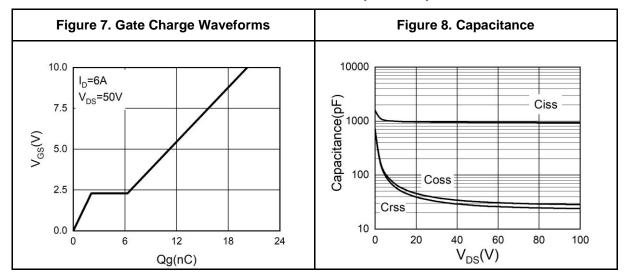
Typical Electrical And Thermal Characteristics (Curves)

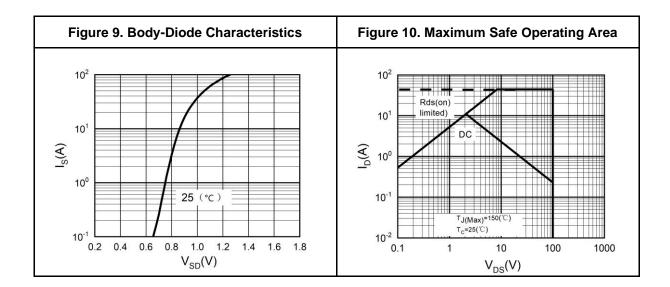






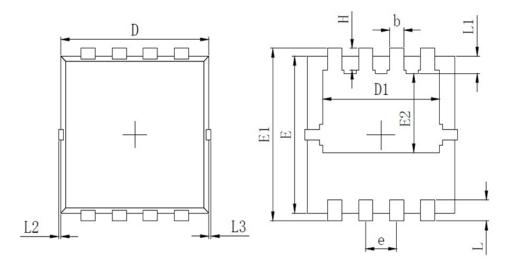
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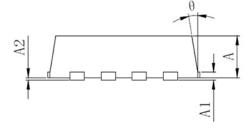




PDFN3X3-8L Package Information



CVAUDOL			
SYMBOL	MIN	Typ.	MAX
A	0.700	0.800	0.900
A1	0.152 REF.		
A2	0~0.05		
D	3.000	3. 100	3. 200
D1	2.300	2. 450	2.600
Е	2.900	3.000	3. 100
E1	3. 150	3. 300	3. 450
E2	1.320	1.520	1.720
b	0.200	0.300	0.400
е	0.550	0.650	0.750
L	0.300	0.400	0.500
L1	0.180	0.330	0.480
L2	0~0. 100		
L3	0~0.100		
Н	0.315	0.415	0.515
θ	8°	10°	12°





Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor

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